Ling Zhu TIDRAX9, TIDM-FRAM-THERMOSTAT

## TI Designs: <TIDM-FRAM-THERMOSTAT>

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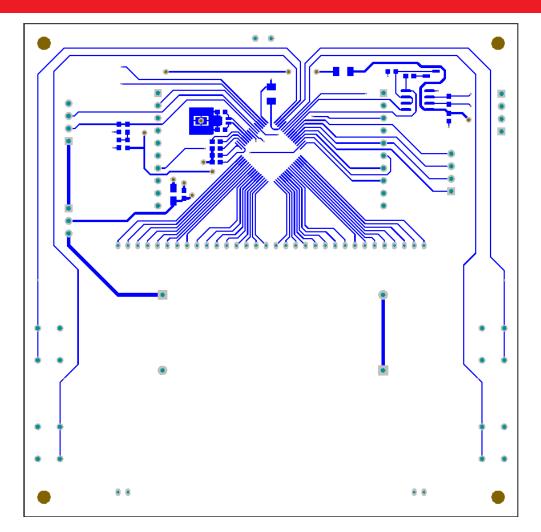
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## TI Designs: <TIDM-FRAM-WATERMETER>





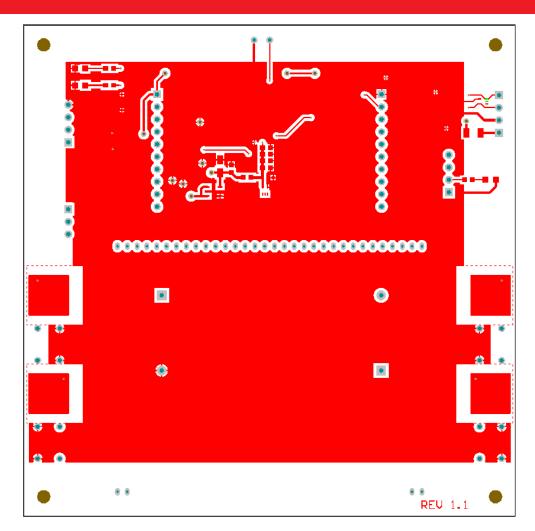


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